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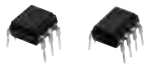
RoHS

■ Photocoupler Lineup

<Phototransistor output type>

Package type	Output type	Features		Model No. (series)	Page
Mini-flat 4-pin Compact, SMT type	Single phototransistor	General purpose, High collector-emitter voltage, etc.		PC35x series / PC451J00000F	41
			Low input current	PC367NJ0000F	41
		AC input response		PC354NJ0000F	41
			Low input current	PC364NJ0000F	41
	Darlington phototransistor	High sensitivity, High collector-emitter voltage		PC355NJ0000F / PC452J00000F	41
			Low input current	PC365NJ0000F	41
Compact, Half pitch (lead space), SMT type	Single phototransistor	General purpose, High resistance to noise, etc.		PC3Hx series	42
			Reinforced insulation	PC3HU7xYIP0B	42
			Low input current	PC3H71xNIP0F	42
		AC input response		PC3H3J00000F / PC3H4J00000F	42
			Low input current	PC3H41xNIP0F	42
	Darlington phototransistor	High sensitivity		PC3H5J00000F	42
			Low input current	PC3H510NIP0F	42
DIP type (4-pin)	Single phototransistor	Reinforced insulation		PC123XNNSZ0F	43
(4-pin, DIP type)		General purpose, High collector-emitter voltage, etc.	Low input current	PC1231xNSZ0X	43
				PC817XNNSZ0F / PC851XNNSZ0F	43
			Low input current	PC8171xNSZ0X	43
	Darlington phototransistor	High sensitivity, High collector-emitter voltage		PC815XNNSZ0F / PC852XNNSZ0F / PC853XNNSZ0F	43
			Low input current	PC81510NSZ0X	43
DIP type (6-pin)	Single phototransistor	General purpose, High collector-emitter voltage, etc.		PC7xxV0NSZXF	44
	Darlington phototransistor	High sensitivity, High collector-emitter voltage, etc.		PC7x5V0NSZXF	44

<OPIC output type>

Package type	Output type	Features	Model No. (series)	Page
Compact, SMT type	Digital output	General purpose, High response speed, 2ch, etc.	PC400J00000F / PC456L0NIP0F▲ / PC410S0NIP0F / PC410L0NIP0F / PC4D10SNIP0F	45
	Analog/Digital output	High CMR	PC457S0NIP0F / PC457L0NIP0F	45
DIP type, SMT type	Digital output	General purpose	PC900V0NSZXF	46
	Built-in base amplifier	For inverter control, Built-in short-circuit protection circuit	PC925LxNSZ0F / PC942J00000F▲ / PC928J00000F / PC929J00000F	46

The model marked with ▲ may not be available in the near future. Contact with SHARP for details before use.

RoHS

■ Photocouplers

◆Phototransistor Output Type <Compact, SMT type>

○: Approved

(Ta = 25°C)

Output type	Model No.	Internal connection diagram	Features	Approved by safety standards*2 UL	Package	Absolute maximum ratings: Forward current IF (mA)	Isolation voltage (AC) Viso (rms) (kV)	Collector-emitter voltage VCEO (V)	Electro-optical characteristics: Current transfer ratio CTR (%) MIN.	IF (mA)	VCE (V)	Response time tr (μs) TYP.	IC (mA)	RL (Ω)	VCE (V)
Single phototransistor output	PC357NJ0000F		General purpose	○*	Mini-flat 4-pin	50	3.75	80	50	5	5	4	2	100	2
	PC352NJ0000F▲		General purpose, high resistance to noise*1	○		50	3.75	80	90	5	5	4	2	100	2
	PC451J00000F		High collector-emitter voltage	○*		50	3.75	350	40	5	5	4	2	100	2
	PC367NJ0000F		Low input current, high resistance to noise*1	○		10	3.75	80	100	0.5	5	4	2	100	2
	PC354NJ0000F		AC input response	○*		±50	3.75	80	20	±1	5	4	2	100	2
	PC364NJ0000F		Low input current, AC input response, high resistance to noise*1	○		±10	3.75	80	50	±0.5	5	4	2	100	2
Darlington photo-transistor output	PC355NJ0000F		High sensitivity	○*		50	3.75	35	600	1	2	60	2	100	2
	PC365NJ0000F		High sensitivity, low input current	○		10	3.75	35	600	0.5	2	60	10	100	2
	PC452J00000F		High collector-emitter voltage	○*		50	3.75	350	1 000	1	2	100	20	100	2

*1 CMR: MIN.10 kV/μs
*2 Please refer to Specification Sheets for model numbers approved by safety standards.
* A VDE approved type is optionally available.
The model marked with ▲ may not be available in the near future. Contact with SHARP for details before use.

PC357NJ0000F
(Mini-flat 4-pin)

Optoelectronics

RoHS

◆Phototransistor Output Type
<Compact, half pitch (lead space) SMT type>

○: Approved

(Ta = 25°C)

Output type	Model No.	Internal connection diagram	Features	Approved by safety standards*3	Package	Absolute maximum ratings			Electro-optical characteristics						
						Forward current IF (mA)	Isolation voltage (AC) Viso (rms) (kV)	Collector-emitter voltage VCEO (V)	Current transfer ratio			Response time			
				UL					CTR (%) MIN.	IF (mA)	VCE (V)	tr (μs) TYP.	IC (mA)	RL (Ω)	VCE (V)
Single phototransistor output	PC3HU7xYIP0B		Reinforced insulation (internal insulation distance: MIN. 0.4 mm), low-profile package	○*4, 5	Low-profile mini-flat 4-pin	50	3.75	80	50	5	5	4	2	100	2
	PC3H7J00000F		Standard	○*6	Mini-flat 4-pin	50	2.5	80	20	1	5	4	2	100	2
	PC3H71xNIP0F		High resistance to noise*1, low input current	○		10	2.5	80	100	0.5	5	4	2	100	2
	PC3H3J00000F		AC input response, high resistance to noise*1	○		±50	2.5	80	20	±1	5	4	2	100	2
	PC3H4J00000F		AC input response	○*2, 6		±50	2.5	80	20	±1	5	4	2	100	2
	PC3H41xNIP0F		AC input response, high resistance to noise*1, low input current	○		±10	2.5	80	50	±0.5	5	4	2	100	2
Darlington photo-transistor output	PC3H5J00000F		High sensitivity	○	Mini-flat 4-pin	50	2.5	35	600	1	2	60	2	100	2
	PC3H510NIP0F		High sensitivity, low input current	○		10	2.5	35	600	0.5	2	60	2	100	2

*1 CMR: MIN.10 kV/μs
*2 A VDE approved type is optionally available.
*3 Please refer to Specification Sheets for model numbers approved by safety standards.
*4 VDE, CSA approved
*5 In conformance with BSI, SEMKO, DEMKO, NEMKO, and FIMKO
*6 UL, cUL approved

PC3HU7xYIP0B

PC3H7J00000F
(Mini-flat 4-pin)

RoHS

◆Phototransistor Output Type
<DIP type (4-pin)>

○: Approved

(Ta = 25°C)

Output type	Model No.	Internal connection diagram	Features	Approved by safety standards*8			Package	Absolute maximum ratings			Electro-optical characteristics			
				UL	VDE *2	Others *3		Forward current I_F (mA)	Isolation voltage (AC) Viso (rms) (kV)	Collector-emitter voltage V_{CEO} (V)	Current transfer ratio CTR (%) MIN.	I_F (mA)	Response time tr (μs) TYP.	R_L (Ω)
Single phototransistor output	PC123XNNSZ0F*1, *5, *6, *7		High isolation voltage, reinforced insulation	○	○	○	4-pin DIP	50	5.0	70	50	5	4	100
	PC1231xNSZ0X*1		High isolation voltage, reinforced insulation, low input current, high resistance to noise*4	○	○	○		10	5.0	70	50	0.5	4	100
	PC817XNNSZ0F*5, *6, *7		High isolation voltage	○	–	○*9		50	5.0	80	50	5	4	100
	PC8171xNSZ0X*5, *6		High isolation voltage, low input current, high resistance to noise*4	○	–	–		10	5.0	80	100	0.5	4	100
	PC851XNNSZ0F*5, *6		High isolation voltage, high collector-emitter voltage	○	–	–		50	5.0	350	40	5	4	100
Darlington phototransistor output	PC815XNNSZ0F*5, *6		High isolation voltage, high sensitivity	○	–	–		50	5.0	35	600	1	60	100
	PC81510NSZ0X		High isolation voltage, high sensitivity, low input current	○	–	–		10	5.0	35	600	0.5	60	100
	PC852XNNSZ0F*5, *6		High isolation voltage, high collector-emitter voltage	○	○	–		50	5.0	350	1 000	1	100	100
	PC853XNNSZ0F*5, *6		High isolation voltage, high collector-emitter voltage	○	○	–		50	5.0	350	1 000	1	100	100

*1 Wide lead spacing type is also available. Creepage distance: 6.4 mm or more, wide lead spacing type: 8 mm or more.
*2 Optionally available.
*3 BSI, SEMKO, DEMKO, NEMKO, FIMKO, CSA
*4 CMR: 10 kV/μs MIN.
*5 Lead forming type is also available for surface mounting.
*6 Taped package of lead forming type for surface mounting is also available.
*7 Wide lead spacing type is also available. Compatible with wide lead spacing type lead-forming models for surface-mount use. Also compatible with taped packages for wide lead spacing type lead-forming models for surface-mount use.
*8 Please refer to Specification Sheets for model numbers approved by safety standards.
*9 UL, CSA approved

PC817XNNSZ0F
(4-pin DIP)

◆Phototransistor Output Type
<DIP type (6-pin)>

○: Approved, △: Under application

(Ta = 25°C)

Output type	Model No.	Internal connection diagram	Features	Approved by safety standards*2		Package	Absolute maximum ratings			Electro-optical characteristics			
				UL	VDE*1		Forward current I_F (mA)	Isolation voltage (AC) Viso (rms) (kV)	Collector-emitter voltage V_{CEO} (V)	Current transfer ratio CTR (%) MIN.	Current transfer ratio I_F (mA)	Response time tr (μs) TYP.	Response time R_L (Ω)
Single phototransistor output	PC714V0NSZXF		High isolation voltage	○	○	6-pin DIP	50	5.0	80	50	5	4	100
	PC724V0NSZXF		High isolation voltage, large input current	○	–		150	5.0	35	20	100	4	100
	PC713V0NSZXF		High isolation voltage, with base terminal	○	○		50	5.0	80	50	5	4	100
Darlington phototransistor output	PC715V0NSZXF		High isolation voltage, high sensitivity	○	○		50	5.0	35	600	1	60	100
	PC725V0NSZXF		High isolation voltage, high sensitivity, high collector-emitter voltage, high power	○	○		50	5.0	300	1 000	1	100	100

*1 Optionally available.
*2 Please refer to Specification Sheets for model numbers approved by safety standards.

PC713V0NSZXF
(6-pin DIP)

RoHS

◆OPIC Output

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<Compact, SMT type> (1-1)

○: Approved

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Approved by safety standards*2		Package	Absolute maximum ratings		Electro-optical characteristics*1						
								Low level output voltage				Threshold input current		
			UL	VDE*3		Forward current I_F (mA)	Isolation voltage (AC) Viso (rms) (kV)	V_{OL} (V) MAX.	Ta (°C)	I_{OL} (mA)	I_F (mA)	I_{FHL} (mA) MAX.	I_{FLH} (mA) MAX.	R_L (Ω)
PC400J00000F		Digital output, normal-off operation	○	–	Mini-flat 5-pin	50	3.75	0.4	0 to +70	16	4	2.0	–	280
PC456L0NIP0F▲		Built-in preamplifier, high speed transmission (2 Mb/s), for flow soldering	○	○		25	3.75	0.6	–40 to +85	2.4	10	5.0	–	20 k
PC410L0NIP0F		High speed (10 Mb/s), High CMR (10 kV/μs), For flow soldering	○	○		20	3.75	0.6	–40 to +85	13	5	5.0	–	350
PC410S0NIP0F		High speed (10 Mb/s), high CMR (10 kV/μs), for flow soldering, Solder heat resistance: 270°C	○	○	SOP 8-pin	20	3.75	0.6	–40 to +85	13	5	5.0	–	350
PC4D10SNIP0F		High speed (10 Mb/s), for flow soldering, Solder heat resistance: 270°C 2ch output	○	–	SOP 8-pin	20	3.75	0.6	–40 to +85	13	5	5.0	–	350

A: Rated voltage circuit
*1 Each item is measured at Vcc=5V. (PC400)
*2 Please refer to Specification Sheets for model numbers approved by safety standards.
*3 Optionally available.
The model marked with ▲ may not be available in the near future. Contact with SHARP for details before use.

<Compact, SMT type> (1-2)

○: Approved

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Approved by safety standards*1		Package	Absolute maximum ratings		Electro-optical characteristics							
								Current transfer ratio				Propagation delay time			
			UL	VDE*2		Forward current I_F (mA)	Isolation voltage (AC) Viso (rms) (kV)	CTR (%) MIN.	I_F (mA)	V_O (V)	V_{CC} (V)	t_{PHL} (μs) TYP.	t_{PLH} (μs) TYP.	R_L (Ω)	I_F (mA)
PC457L0NIP0F		High speed (1 Mb/s), high CMR (15 kV/μs), for flow soldering	○	○	Mini-flat 5-pin	25	3.75	19	16	0.4	4.5	0.2	0.4	1 900	16
PC457S0NIP0F		High speed (1 Mb/s), high CMR (15 kV/μs), for flow soldering, Solder heat resistance: 270°C	○	○	SOP 8-pin	25	3.75	19	16	0.4	4.5	0.2	0.3	1 900	16

*1 Please refer to Specification Sheets for model numbers approved by safety standards.
*2 Optionally available.


PC400J00000F
(Mini-flat 5-pin)


PC410S0NIP0F
(SOP 8-pin)

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<DIP type, digital output>

○: Approved

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Approved by safety standards*5		Package	Absolute maximum ratings		Electro-optical characteristics*1						
			UL	VDE *4		Forward current I_F (mA)	Isolation voltage (AC) Viso (rms) (kV)	Low level output voltage				Threshold input current		
								V_{OL} (V) MAX.	Ta (°C)	I_{OL} (mA)	I_F (mA)	I_{FHL} (mA) MAX.	I_{FLH} (mA) MAX.	R_L (Ω)
PC900V0NSZXF*2, *3		Digital output, normal-off operation	○	○	6-pin DIP	50	5.0	0.4	0 to +70	16	4	2.0	–	280

A: Rated voltage circuit
*1 Each item is measured at Vcc=5V.
*2 Lead forming type is also available for surface mounting.
*3 Taped package of lead forming type for surface mounting is also available.
*4 Optionally available.
*5 Please refer to Specification Sheets for model numbers approved by safety standards.

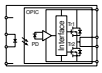
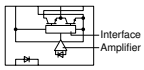
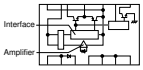
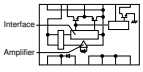
PC900V0NSZXF
(6-pin DIP)

◆OPIC Output ("OPIC" (Optical IC) is a trademark of SHARP Corporation. An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.)

<DIP type, Gate drive type>

○: Approved

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Approved by safety standards*3		Package	Absolute maximum ratings		Electro-optical characteristics					
			UL	VDE *2		Forward current I_F (mA)	Isolation voltage (AC) Viso (rms) (kV)	Propagation delay time					
								t_{PHL} (µs) TYP.	t_{PLH} (µs) TYP.	V_{CC} (V)	I_F (mA)	R_{L1} (Ω)	R_{L2} (Ω)
PC925LxNSZ0F*1		• Built-in drive circuit directly connectable to MOS-FET and IGBT • Peak output current: 2.5 A • Low dissipation current (Icc = TYP. 2.5 mA) • High resistance to noise (CMR: MIN. 15 kV/µs)	○	○	8-pin DIP	25	5.0	MAX. 0.5	MAX. 0.5	15 to 30	7 to 16	R_G = 10	–
PC942J00000F▲		For controlling inverter-controlled air-conditioner	○	○		25	5.0	2.0	2.0	6	5	5	10
PC928J00000F		For driving inverter IGBT, built-in short protection circuit	○	○	14-pin SMT (Half pitch lead)	25	4.0	1.0	1.0	24	10	R_G = 47	–
PC929J00000F		For driving inverter IGBT, high speed, built-in short protection circuit	○	○		20	4.0	0.3	0.3	24	5	R_G = 47	–

*1 Lead forming type is also available for surface mounting. Taped package of lead forming type for surface mounting is also available.
*2 A VDE approved type is optionally available.
*3 Please refer to Specification Sheets for model numbers approved by safety standards.
The model marked with ▲ may not be available in the near future. Contact with SHARP for details before use.

PC925LENSZ0F, PC942J00000F▲
(8-pin DIP)

PC928J00000F
(PC929J00000F)

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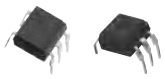
RoHS

■ Phototriac Coupler Lineup

Package	Applied voltage	ON-state current (rms)	Features		Model No.	Page
Mini-flat (SMD)	AC 200 V lines (V_{DRM} = 600V)	0.05 A	General purpose		S2S3000F*3 / S2S5A00F*3 / S2S5FA0F*3	48
				Built-in zero-cross circuit	S2S4000F*3	49
DIP type	AC 200 V lines (V_{DRM} = 600V)	0.1 A	General purpose		PC3ST11NSZAX*3	48
(4-pin)				Built-in zero-cross circuit	PC3ST21NSZBX*2	49
			Reinforced isolation		PC3SH11YFZAX*3 / PC3SH13YFZAX*3	48
				Built-in zero-cross circuit	PC3SH21YFZBX*2	49
DIP type	AC 100 V lines (V_{DRM} = 400V)	0.1 A	General purpose		PC2SD11NTZAF*3 / PC1S3021NTZF*4	48
(6-pin package, 5th-pin cut)	AC 200 V lines (V_{DRM} = 600V)	0.1 A	General purpose		PC3SD12NTZAF*3 / PC3SD12NTZBF*2 / PC3SD12NTZCF*1 / PC1S3052YTZF*3 / PC3SD11NTZCF*1 / PC3SD13NTZBF*2	48
				Built-in zero-cross circuit	PC3SD21NTZAF*3 / PC3SD21NTZBF*2 / PC3SD21NTZCF*1 / PC3SD21NTZDF*5 / PC3SD23YTZCF*1 / PC1S3063YTZF*1	49
			Reinforced isolation		PC3SF11YVZAF*3 / PC3SF11YVZBF*2 / PC3SF13YVZBF*2	48
				Built-in zero-cross circuit	PC3SF21YVZAF*3 / PC3SF21YVZBF*2 / PC3SF23YVZSF*2	49
	AC 200 V lines (V_{DRM} = 800V)	0.1 A	General purpose		PC4SD11NTZBF*2 / PC4SD11NTZCF*1	48
				Built-in zero-cross circuit	PC4SD21NTZCF*1 / PC4SD21NTZDF*5	49
			Reinforced isolation		PC4SF11YVZAF*3 / PC4SF11YVZBF*2	48
				Built-in zero-cross circuit	PC4SF21YVZBF*2 / PC4SF21YVZCF*1 / PC4SF21YWPSF*2	49

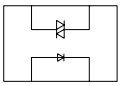
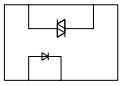
Minimum trigger current: *1 I_{FT} ≦ 5 mA, *2 I_{FT} ≦ 7 mA, *3 I_{FT} ≦ 10 mA, *4 I_{FT} ≦ 15 mA, *5 I_{FT} ≦ 3 mA

RoHS

■ Phototriac Couplers

○: Approved

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Approved by safety standards*4			Package	Absolute maximum ratings			Electro-optical characteristics
			UL, CSA	VDE	Others		ON-state current I_T (rms) (A)	Repetitive peak OFF-state voltage V_{DRM} (V)	Isolation voltage (AC) Viso (rms) (kV)	Min. trigger current I_{FT} (mA) MAX. V_D = 6 V, R_L = 100Ω
S2S3000F		200 V lines, compact	○	○*6	–	Mini-flat 4-pin	0.05	600	3.75	10
S2S5A00F		200 V lines, compact	○	○*6	–					10
S2S5FA0F		High impulse noise product	○	○*6	–					10
PC3ST11NSZAX		200 V lines, compact	○	○*6	–	4-pin DIP	0.1		5.0	10
PC3SH11YFZAX		200 V lines, compact, reinforced isolation	○	○	○*2					10
PC3SH13YFZAX		200 V lines, compact, reinforced isolation, high noise resistance	○	○	○*2					10
PC2SD11NTZAF		100 V lines	○	–	–	6-pin DIP*1, 3	0.1	400	5.0	10
PC1S3021NTZF		100 V lines	○	–	○*2					10
PC3SD12NTZAF		200 V lines	○	○*6	–			600		10
PC1S3052YTZF		200 V lines	○	○*6	○*2					10
PC3SD12NTZBF		200 V lines	○	○*6	–					7
PC3SD13NTZBF		High impulse noise product	○	○*6	–					7
PC3SD12NTZCF		200 V lines	○	○*6	–					5
PC4SD11NTZBF		200 V lines, repetitive peak-OFF-state voltage	○	○*6	–			800		7
PC3SD11NTZCF		200 V lines	○	○*6	–			600		5
PC4SD11NTZCF		200 V lines, repetitive peak-OFF-state voltage	○	○*6	–			800		5
PC3SF11YVZAF		200 V lines, reinforced isolation	○	○	○*2			600		10
PC3SF11YVZBF		200 V lines, reinforced isolation	○	○	○*2					7
PC3SF13YVZBF		200 V lines, reinforced isolation, high noise resistance	○	○	○*2					7
PC4SF11YVZAF		200 V lines, reinforced isolation, repetitive peak-OFF-state voltage	○	○	○*2			800		10
PC4SF11YVZBF		200 V lines, reinforced isolation, repetitive peak-OFF-state voltage	○	○	○*2					7

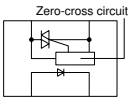
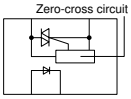
For the notes *1 to *6, see next page.

RoHS

■ Phototriac Couplers
(Built-in zero-cross circuit type)

○: Approved

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Approved by safety standards*4			Package	Absolute maximum ratings			Electro-optical characteristics
			UL, CSA	VDE	Others		ON-state current IT (rms) (A)	Repetitive peak OFF-state VDRM (V)	Isolation voltage (AC) Viso (rms) (kV)	Min. trigger current IFT (mA) MAX. VD = 4 V, RL = 100Ω
S2S4000F		200 V lines, compact	○	○*6	–	Mini-flat 4-pin	0.05	600	3.75	10*5
PC3ST21NSZBX		200 V lines, compact	○	○*6	–	4-pin DIP	0.1	600	5.0	7
PC3SH21YFZBX		200 V lines, compact, reinforced isolation	○	○	○*2					7
PC3SD21NTZAF		200 V lines, low zero-cross voltage: MAX. 20 V	○	○*6	–	6-pin DIP*1, 3	0.1	600	5.0	10
PC3SD21NTZBF		200 V lines, low zero-cross voltage: MAX. 20 V	○	○*6	–					7
PC3SD21NTZCF		200 V lines, low zero-cross voltage: MAX. 20 V	○	○*6	–					5
PC1S3063YTZF		100 V lines, low zero-cross voltage: MAX. 20 V	○	○*6	○*2					5
PC3SD23YTZCF		200 V lines, high pulse/noise resistance (TYP. 2 kV)	○	○	–					5
PC3SD21NTZDF		200 V lines, low zero-cross voltage: MAX. 20 V	○	○*6	–					3
PC4SD21NTZCF		200 V lines, repetitive peak-OFF-state voltage	○	○*6	–			800		5
PC4SD21NTZDF		200 V lines, repetitive peak-OFF-state voltage	○	○*6	–					3
PC3SF21YVZAF		200 V lines, reinforced isolation	○	○	○*2			600		10
PC3SF21YVZBF		200 V lines, reinforced isolation	○	○	○*2					7
PC3SF23YVZSF		High impulse noise product	○	○	○*2					7
PC4SF21YVZBF		200 V lines, reinforced isolation, repetitive peak-OFF-state voltage	○	○	○*2			800		7
PC4SF21YVZCF		200 V lines, reinforced isolation, repetitive peak-OFF-state voltage	○	○	○*2					5
PC4SF21YWPSF		High impulse noise product	○	○	○*2	6-pin DIP*3				7

*1 Lead forming type for surface mounting is also available.
*2 In conformance with BSI, SEMKO, DEMKO, and FIMKO
*3 These are molded pin No. 5.
*4 Please refer to Specification Sheets for model numbers approved by safety standards.
*5 VD = 6 V, RL = 100Ω
*6 Optionally available


S2S3000F
(Mini-flat 4-pin)


PC2SD series
(PC3SD series, PC4SD series)
(6-pin DIP)


PC3SF series
(PC4SF series)
(6-pin DIP)


PC3ST series
(4-pin DIP)


PC3SH series
(4-pin DIP)

RoHS

■ Solid State Relay Lineup

Package	Applied voltage	ON-state current (rms)	Features	Model No.	Page
DIP 6-pin	AC 100 V lines	0.15 A	General purpose	PR22MA11NTZF	51
	AC 200 V lines	0.06 A	General purpose	PR31MA11NTZF	51
		0.15 A	General purpose	PR32MA11NTZF	51
		0.3 A	General purpose	PR33MA series	51
DIP 8-pin	AC 100 V lines	0.3/0.6/0.9 A	General purpose	PR23MF11NSZF / PR26MF series / PR29MF series	51
		0.6/0.9 A	Built-in zero-cross circuit	PR26MF21NSZF / PR29MF21NSZF	51
	AC 200 V lines	0.3/0.6/0.9/1.2 A	General purpose	PR33MF5 series / PR39MF5 series / PR36MF5 series / PR3BMF5 series	51
		0.6/0.9/1.2 A	Built-in zero-cross circuit	PR36MF2 series / PR39MF2 series / PR3BMF21NSZF	51
SIP 4-pin	AC 100 V lines	2/8 A 3 to 16 A	General purpose	S102T01F*1 / S108T01F*1 / S101S05F / S102S01F / S112S01F / S116S01F	52
 Low profile		2/8 A 3 to 16 A	Built-in zero-cross circuit	S102T02F*1 / S108T02F*1 / S101S06F / S102S02F / S116S02F	52
		8 A	Built-in snubber circuit	S102S11F	52
		3/8 A	Built-in snubber circuit/ zero-cross circuit	S101S16F / S102S12F	52
	AC 200 V lines		General purpose	S202T01F*1 / S208T01F*1 / S202S01F / S212S01F / S216S01F	52
		2/8 A 3 to 16 A	Built-in zero-cross circuit	S202T02F*1 / S208T02F*1 / S201S06F / S202S02F / S216S02F	52/53
		8/8 A	Built-in snubber circuit	S202S15F / S202S11F	53
		8 A	Built-in snubber circuit/ zero-cross circuit	S202S12F	53

*1 Low profile

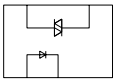
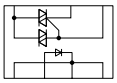
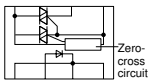
☆New product

■ Solid State Relays

<DIP type>

○: Approved

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Approved by safety standards*1			Package	Absolute maximum ratings			Electrical characteristics
			UL	CSA	VDE*2		ON-state current IT (rms) (A)	Repetitive peak OFF-state voltage VDRM (V)	Isolation voltage (AC) Viso (rms) (kV)	Min. trigger current IFT (mA) MAX. VD = 6 V, RL = 100Ω
PR22MA11NTZF		100 V lines, 150 mA model in a small package	○	○	○	6-pin DIP	0.15	400	5.0	10
PR31MA11NTZF		200 V lines, compact	○	○	○		0.06	600		10
PR32MA11NTZF		200 V lines, 150 mA model in a small package	○	○	○		0.15			10
☆PR33MA series		200 V lines, 300 mA model in a small package	○	○	○		0.3			15
PR23MF11NSZF		100 V lines, compact	○	○	–	8-pin DIP	0.3	400	4.0	10
PR26MF11NSZF		100 V lines, compact	○	○	–		0.6			10
PR26MF12NSZF		100 V lines, compact, low input current	○	○	–					5
PR29MF11NSZF		100 V lines, compact	○	○	–		0.9			10
PR29MF12NSZF		100 V lines, compact, low input current	○	○	–					5
PR33MF51NSLF		200 V lines, compact	○	○	○		0.3	600		10
PR33MF52NSLF		200 V lines, compact	○	○	○					10
PR36MF51NSLF		200 V lines, compact	○	○	○		0.6			10
PR36MF12NSZF		200 V lines, compact, low input current	○	○	○					5
PR39MF51NSLF		200 V lines, compact	○	○	○		0.9			10
PR39MF12NSZF		200 V lines, compact, low input current	○	○	○					5
PR3BMF51NSLF		200 V lines, compact	○	○	○		1.2			10
PR3BMF52NSZF		200 V lines, compact, low input current	○	○	○					5
PR26MF21NSZF		100 V lines, compact (built-in zero-cross circuit)	○	○	–		0.6	400		10
PR29MF21NSZF		100 V lines, compact (built-in zero-cross circuit)	○	○	–		0.9			10
PR36MF21NSZF		200 V lines, compact (built-in zero-cross circuit)	○	○	○		0.6	600		10
PR36MF22NSZF		200 V lines, compact (built-in zero-cross circuit), low input current	○	○	○					5
PR39MF21NSZF		200 V lines, compact (built-in zero-cross circuit)	○	○	○		0.9			10
PR39MF22NSZF		200 V lines, compact (built-in zero-cross circuit), low input current	○	○	○					5
PR3BMF21NSZF		200 V lines, compact (built-in zero-cross circuit)	○	○	○		1.2			10

*1 Please refer to Specification Sheets for model numbers approved by safety standards.
*2 Optionally available.

PR22MA11NTZF
(6-pin DIP)

PR26MF21NSZF
(8-pin DIP)

Notice
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*RoHS Directive: Prohibits use of lead, cadmium, hexavalent chromium, mercury and specific brominated flame retardants (PBBs and PBDEs), with certain exceptions.
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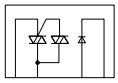
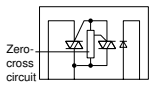
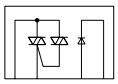
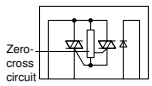
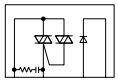
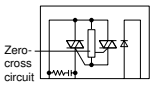
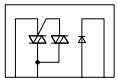
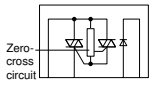
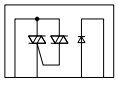
RoHS

<SIP type> (1)

○: Approved

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Approved by safety standards*6		Package	Absolute maximum ratings			Electrical characteristics		
			UL	CSA		ON-state current I_T (rms) (A)	Repetitive peak OFF-state voltage V_{DRM}(V)	Isolation voltage (AC) Viso (rms) (kV)	Min. trigger current I_{FT} (mA) MAX.	V_D (V)	R_L (Ω)
S102T01F		100 V lines, low profile	○	○	Low profile 4-pin SIP	2	400	3.0	8	12	30
S108T01F		100 V lines, low profile	–	–		8*2			8	12	30
S102T02F		100 V lines, low profile (built-in zero-cross circuit)	○	○		2			8	12	30
S108T02F		100 V lines, low profile (built-in zero-cross circuit)	–	–		8*2			8	12	30
S101S05F		100 V lines	○	○	4-pin SIP	3*3			15	12	30
S102S01F		100 V lines	○	○		8*2		4.0	8	12	30
S112S01F		100 V lines	○	○		12*4			8	12	30
S116S01F		100 V lines	○	○		16*5			8	12	30
S101S06F		100 V lines (built-in zero-cross circuit)	○	○		3*3		3.0	15	6	30
S102S02F		100 V lines (built-in zero-cross circuit)	○	○		8*2		4.0	8	6	30
S116S02F		100 V lines (built-in zero-cross circuit)	○	○		16*5			8	6	30
S102S11F		100 V lines (built-in snubber circuit)	○	○		8*1			8	12	30
S101S16F		100 V lines (built-in snubber circuit, built-in zero-cross circuit)	○	○		3*3		3.0	15	6	30
S102S12F		100 V lines (built-in snubber circuit, built-in zero-cross circuit)	○	○		8*1		4.0	8	6	30
S202T01F		200 V lines, low profile	○	○	Low profile 4-pin SIP	2	600	3.0	8	12	30
S208T01F		200 V lines, low profile	–	–		8*2			8	12	30
S202T02F		200 V lines, low profile (built-in zero-cross circuit)	○	○		2			8	12	30
S208T02F		200 V lines, low profile (built-in zero-cross circuit)	–	–		8*2			8	12	30
S202S01F		200 V lines	○	○	4-pin SIP	8*2		4.0	8	12	30
S212S01F		200 V lines	–	–		12*4			8	12	30
S216S01F		200 V lines	–	–		16*5			8	12	30

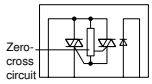
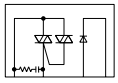
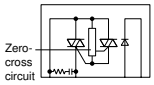
For the notes *1 to *6, see next page.

RoHS

<SIP type> (2)

○: Approved

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Approved by safety standards*6		Package	Absolute maximum ratings			Electrical characteristics		
			UL	CSA		ON-state current I_T (rms) (A)	Repetitive peak OFF-state voltage V_{DRM}(V)	Isolation voltage (AC) Viso (rms) (kV)	Min. trigger current I_{FT} (mA) MAX.	V_D (V)	R_L (Ω)
S201S06F		200 V lines (built-in zero-cross circuit)	○	○	4-pin SIP	3*3	600	3.0	15	6	30
S202S02F		200 V lines (built-in zero-cross circuit)	○	○		8*2		4.0	8	6	30
S216S02F		200 V lines (built-in zero-cross circuit)	–	–		16*5			8	6	30
S202S15F		200 V lines (built-in snubber circuit)	–	–		8*2		3.0	15	12	30
S202S11F		200 V lines (built-in snubber circuit)	○	○		8*1		4.0	8	12	30
S202S12F		200 V lines (built-in snubber circuit, built-in zero-cross circuit)	○	○		8*1			8	6	30

*1 Tc ≦ 88°C *2 Tc ≦ 80°C *3 Tc ≦ 100°C *4 Tc ≦ 70°C *5 Tc ≦ 60°C

*6 Please refer to Specification Sheets for model numbers approved by safety standards.

S102T01F series
(Low profile 4-pin SIP)

S102S02F series
(4-pin SIP)

Optoelectronics

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RoHS

■ Photointerrupter Lineup

<Transmissive type>

Output type	Package type	Outline	Mounting method	Model No. (series)	Page
Single phototransistor	Compact	High resolution	PWB mounting type	GP1S396HCP0F / GP1S09xHCZ0F / GP1S19xHCZ0F	55
High response speed			Surface-mount type/ Soldering reflow	GP1S396HCPSF / GP1S296HCPSF / GP1S092HCPIF / GP1S19xHCxSF	55
	Case type	High resolution	PWB mounting type, etc.	GP1S5x series	56
		Horizontal slit, High resolution	PWB mounting type	GP1S59J0000F	56
	With connector	General purpose	Snap-in	GP1S173LCS2F / GP1S273LCS1F	56
Darlington phototransistor	Case type	General purpose	PWB mounting type, etc.	GP1L5x series	57
High sensitivity		Wide gap	PWB mounting type	GP1L57J0000F	57
Digital output	Compact	High voltage	PWB mounting type	GP1A98HCZ0F	57
(OPIC output)			Surface-mount type	GP1A98HCPSF	57
	Case type	High resolution	With screw hole/ PWB mounting type	GP1A5x series	58
		Wide gap	PWB mounting type	GP1A57HRJ00F	58
	With connector	General purpose	Screw mounting type/Snap-in	GP1A173LCS3F / GP1A173LCS2F / GP1A173LCSVF / GP1A273LCS1F	59

<Reflective type>

Output type	Package type	Outline	Mounting method	Model No. (series)	Page
Single phototransistor	Leadless	Long focal distance	Surface-mount type	GP2S700HCP	59
High response speed	Compact, thin (leadless)	General purpose	Surface-mount type	GP2S60	59
OPIC output	With connector	Light modulation type, Sensitivity adjusted	Screw mounting type/ Compact snap-in/ Inverter light countermeasures	GP2A25 series / GP2A28 series / GP2A200LCS0F / GP2A230LRS0F / GP2A231LRSAF / GP2A230LRSAF / GP2A240LCS0F / GP2A250LCS0F	60

<Application-specific photointerrupter lineup>

Detection type	Outline (Output type etc.)		Mounting method	Model No. (series)	Page
Transmissive type	Case type With encoder function Digital 2 output (phase A/B)	Resolution: 45 LPI Linear scale slit pitch: 0.56 mm	PWB mounting type	GP1A057SGKLF	61
		Resolution: 150 LPI Linear scale slit pitch: 0.17 mm	PWB mounting type	GP1A057RBKLF	61
		Resolution: 180 LPI Linear scale slit pitch: 0.14 mm	With screw hole/ PWB mounting type	GP1A058SCK0F	61
		Resolution: 300 LPI Linear scale slit pitch: 0.0847 mm	With screw hole/ PWB mounting type	GP1A054RDKLF	61
	Case type With encoder function Digital 2 output (Multiplying output)	Resolution for reading: 180 LPI Pitch: 0.14 mm Output resolution: 360 LPI	With screw hole/ PWB mounting type	GP1A101C2KSF	61
	For amusement use		Screw mounting	GP1A204HCS0	61
Reflective type	Injection For prism system (Single phototransistor)		Screw mounting	GP2S29SVJ00F	61
	For amusement use (Pachinko ball sensor)		–	GP2A222HCKA	62

RoHS

■ Photointerrupters

<Transmissive type>

◆Single Phototransistor Output

<Compact type>

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Detecting and emitting gap (mm)	Slit width (mm)	Electro-optical characteristics						
					Current transfer ratio			Response time			
					CTR (%) MIN.	I_F (mA)	V_{CE} (V)	tr (μs) TYP.	I_C (mA)	R_L (kΩ)	V_{CE} (V)
GP1S092HCPIF		Wide gap, for soldering reflow, surface mount compatible, with positioning boss (4.5 × 2.6 × 2.9 [height] mm)	2.0	0.3	2.0	5	5	50	0.1	1	5
GP1S093HCZ0F		Wide gap (4.5 × 2.6 × 2.9 [height] mm)	2.0	0.3	2.0	5	5	50	0.1	1	5
GP1S094HCZ0F		Wide gap, with positioning pin, (5.5 × 2.6 × 4.8 [height] mm)	3.0	0.3	0.8	5	5	50	0.1	1	5
GP1S096HCZ0F		Narrow gap (3.5 × 2.6 × 2.9 [height] mm)	1.0	0.3	2.0	5	5	50	0.1	1	5
GP1S194HCZ0F		Compact, wide gap, size: 3.6 × 2.0 × 2.7 (height) mm	1.7	0.3	3.0	5	5	50	0.1	1	5
GP1S195HCZSF GP1S195HCPSF		Compact, wide gap, surface mount compatible, size: 3.4 × 2.0 × 2.7 (height) mm	1.5	0.3	3.0	5	5	50	0.1	1	5
GP1S196HCZ0F		Compact, low profile (3.1 × 2.0 × 2.7 [height] mm)	1.1	0.3	2.0	5	5	50	0.1	1	5
GP1S196HCZSF GP1S196HCPSF		Surface mount, for soldering reflow, compact, low profile (3.1 × 2.0 × 2.7 [height] mm)	1.1	0.3	2.0	5	5	50	0.1	1	5
GP1S296HCPSF		Surface mount, for soldering reflow, compact, low profile (2.5 × 1.8 × 1.9 [height] mm)	1.0	0.2	3.0	5	5	50	0.1	1	5
GP1S396HCP0F		Straight lead type, compact, low profile (2.26 × 1.4 × 1.6 [height] mm)	1.2	0.12	2.0	5	5	30	0.1	1	5
GP1S396HCPSF		Surface mount, for soldering reflow, compact, low profile (2.26 × 1.4 × 1.6 [height] mm)	1.2	0.12	2.0	5	5	30	0.1	1	5
GP1S097HCZ0F		High resolution, wide gap, with mounting hole (4.5 × 2.6 × 4.5 [height] mm)	2.0	0.3	2.0	5	5	50	0.1	1	5

✳ Topr: –25 to +85°C

✳✳ GP1SxxxHCZxF: Sleeve package, GP1SxxxHCPxF: Taped package


GP1S092HCPIF


GP1S093HCZ0F


GP1S094HCZ0F


GP1S096HCZ0F


GP1S194HCZ0F


GP1S195HCPSF/
GP1S195HCZSF


GP1S196HCZ0F


GP1S196HCZSF/
GP1S196HCPSF


GP1S296HCPSF


GP1S396HCPSF

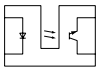

GP1S396HCP0F


GP1S097HCZ0F

RoHS

<Case type>

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Detecting and emitting gap (mm)	Slit width (mm)	Electro-optical characteristics						
					Current transfer ratio			Response time			
					CTR (%) MIN.	I_F (mA)	V_{CE} (V)	tr (µs) TYP.	I_C (mA)	R_L (Ω)	V_{CE} (V)
GP1S50J0000F		High resolution, both-side mounting type	3.0	0.5	2.5	20	5	3	2	100	2
GP1S51VJ000F		High resolution, side mounting type	3.0	0.5	2.5	20	5	3	2	100	2
GP1S52VJ000F		High resolution, PWB mounting type	3.0	0.5	2.5	20	5	3	2	100	2
GP1S53VJ000F		High resolution, PWB mounting type	5.0	0.5	2.5	20	5	3	2	100	2
GP1S54J0000F		High resolution, with positioning pin, PWB mounting type	3.0	0.5	2.5	20	5	3	2	100	2
GP1S56TJ000F		High resolution, with positioning pin, PWB mounting type	2.0	0.15	2.0	20	5	38	0.5	1 000	2
GP1S58VJ000F		High resolution, with positioning pin, PWB mounting type	5.0	0.5	2.5	20	5	3	2	100	2
GP1S59J0000F		High resolution, horizontal slit, with positioning pin, PWB mounting type	4.2	0.5	2.5	20	5	3	2	100	2

✻ Topr: –25 to +85°C

GP1S50J0000F

GP1S51VJ000F

GP1S52VJ000F

GP1S53VJ000F

GP1S54J0000F

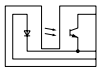
GP1S56TJ000F

GP1S58VJ000F

GP1S59J0000F

<With connector>

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Detecting and emitting gap (mm)	Slit width (mm)	Electro-optical characteristics						
					Current transfer ratio			Response time			
					CTR (%) MIN.	I_F (mA)	V_{CE} (V)	tr (µs) TYP.	I_C (mA)	R_L (Ω)	V_{CE} (V)
GP1S173LCS2F		Snap-in mounting integrated connector type Applicable to 3 kinds of thickness of mounting boards	5.0	0.5	2.5	20	5	3	2	100	2
GP1S273LCS1F		Snap-in mounting integrated connector type Applicable to 3 kinds of thickness of mounting boards Compact (Compatible with 1.5 mm pitch connector)	5.0	0.7	2.5	20	5	3	2	100	2

✻ Topr: –25 to +85°C, –30 to +95°C (GP1S173LCS2F, GP1S273LCS1F)

GP1S173LCS2F

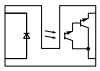
GP1S273LCS1F

RoHS

◆Darlington Phototransistor Output

<Case type>

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Detecting and emitting gap (mm)	Slit width (mm)	Electro-optical characteristics						
					Current transfer ratio			Response time			
					CTR (%) MIN.	I_F (mA)	V_{CE} (V)	tr (µs) TYP.	I_C (mA)	R_L (Ω)	V_{CE} (V)
GP1L50J0000F		High sensitivity, both-side mounting type	3.0	0.5	50	1	2	80	2	100	2
GP1L51J0000F		High sensitivity, side mounting type	3.0	0.5	50	1	2	80	2	100	2
GP1L52VJ000F		High sensitivity, PWB mounting type	3.0	0.5	50	1	2	80	2	100	2
GP1L53VJ000F		High sensitivity, PWB mounting type	5.0	0.5	30	1	2	80	2	100	2
GP1L57J0000F		High sensitivity, wide gap, PWB mounting type	10.0	1.8	70	1	2	130	2	100	2

※ Topr: –25 to +85°C


GP1L50J0000F


GP1L51J0000F


GP1L52VJ000F


GP1L53VJ000F

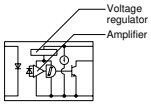

GP1L57J0000F

◆OPIC Type

("OPIC" (Optical IC) is a trademark of SHARP Corporation. An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.)

<Compact type>

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Detecting and emitting gap (mm)	Slit width (mm)	Electro-optical characteristics									
					Threshold input current				Propagation delay time					
					I_{FLH} (mA) MAX.	I_{FHL} (mA) MAX.	V_{CC} (V)	R_L (kΩ)	t_{PLH} (µs) TYP.	t_{PHL} (µs) TYP.	I_F (mA)	R_L (kΩ)	V_{CC} (V)	
GP1A98HCZ0F		Compact, PWB mounting	3.2	0.5	8	–	3.3 to 24	3.9 to 20	2.0	10.0	10	3.9 to 20	3.3 to 24	
GP1A98HCPSF		Compact, surface mount	3.2	0.5	8	–	3.3 to 24	3.9 to 20	2.0	10.0	10	3.9 to 20	3.3 to 24	

※ Topr = –25 to +85°C

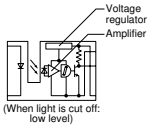
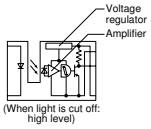

GP1A98HCZ0F


GP1A98HCPSF

RoHS

<Case type>

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Detecting and emitting gap (mm)	Slit width (mm)	Electro-optical characteristics							
					Threshold input current			Propagation delay time				
					I_{FLH} (mA) MAX.	I_{FHL} (mA) MAX.	V_{CC} (V)	t_{PLH} (µs) TYP.	t_{PHL} (µs) TYP.	I_F (mA)	R_L (Ω)	V_{CC} (V)
GP1A50HRJ00F		Both-side mounting, with screw hole	3.0	0.5	5	–	5	3	5	5	280	5
GP1A51HRJ00F		Side mounting, with screw hole	3.0	0.5	5	–	5	3	5	5	280	5
GP1A52HRJ00F		PWB mounting type	3.0	0.5	5	–	5	3	5	5	280	5
GP1A53HRJ00F		PWB mounting type	5.0	0.5	8	–	5	3	5	8	280	5
GP1A57HRJ00F		PWB mounting type, with positioning pin	10.0	1.8	7	–	5	3	5	7	280	5
GP1A58HRJ00F		PWB mounting type, with positioning pin	5.0	0.5	8	–	5	3	5	8	280	5
GP1A52LRJ00F		PWB mounting type	3.0	0.5	–	5	5	5	3	5	280	5

✻ Topr = –25 to +85°C

GP1A50HRJ00F

GP1A51HRJ00F

GP1A52LRJ00F
(GP1A52HRJ00F)

GP1A53HRJ00F
{GP1A58HRJ00F with positioning pin}

GP1A57HRJ00F

☆New product

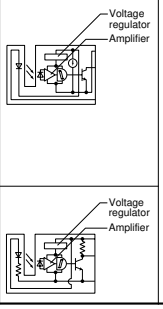
RoHS

◆OPIC Type

("OPIC" (Optical IC) is a trademark of SHARP Corporation. An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.)

<With 3-pin connector terminal>

(Ta = 25°C)

Model No.	Internal connection diagram	Features		Detecting and emitting gap (mm)	Slit width (mm)	Electro-optical characteristics					
						Supply voltage V_{CC} (V)		Low level output voltage			
						MIN.	MAX.	V_{OL} (V) MAX.	Light cut-off	I_{OL} (mA)	V_{CC} (V)
☆GP1A173LCS3F		with 3-pin connector	Snap-in mounting integrated connector type*1	5.0	0.5	2.7	5.5	0.35	No	4	3.3
GP1A173LCS2F			Snap-in mounting integrated connector type*1	5.0	0.5	4.5	5.5	0.35	No	4	5
GP1A173LCSVF			Snap-in mounting integrated connector type*1, enforced electrostatic discharge (ESD) type	5.0	0.5	4.5	5.5	0.35	No	4	5
GP1A273LCS1F			Integrated connector, compatible with 1.5 mm pitch connector, snap-in mounting type*1	5.0	0.7	4.5	5.5	0.35	No	4	5
GP1A75EJ000F▲			Either-side mounting type Screw mounting type	5.0	0.5	4.5	5.5	0.35	Yes	16	5

※ Topr: –20 to +75°C, –30 to +95°C (GP1A173LCS3F, GP1A173LCS2F, GP1A173LCSVF, GP1A273LCS1F)
*1 Applicable to 3 kinds of thickness of mounting boards.
The model marked with ▲ may not be available in the near future. Contact with SHARP for details before use.

GP1A173LCS3F, GP1A173LCS2F, GP1A173LCSVF

GP1A273LCS1F

GP1A75EJ000F▲

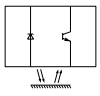
■ Photointerrupters

<Reflective type>

◆Single Phototransistor Output

<Compact>

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Optimum detecting distance (mm)	Electro-optical characteristics						
				Current transfer ratio			Response time			
				CTR (%) MIN.	I_F (mA)	V_{CE} (V)	tr (μs) TYP.	I_C (mA)	R_L (kΩ)	V_{CE} (V)
GP2S700HCP		Compact (4 × 3 × 2 [height] mm), long focal distance, surface mounting leadless type	4	1.5	4	2	20	0.1	1	2
GP2S60		Thin (3.2 × 1.7 × 1.1 [height] mm), surface mounting leadless type	1	1.0	4	2	20	0.1	1	2

※ Topr: –25 to +85°C

GP2S700HCP

GP2S60

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◆OPIC Output

("OPIC" (Optical IC) is a trademark of SHARP Corporation. An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.)

<With 3-pin connector terminal>

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Optimum detecting distance (mm)	Electro-optical characteristics					
				Supply voltage V_{CC} (V)		Dissipation current		Low level output voltage	
				MIN.	MAX.	I_{CC} (mA) MAX.	V_{CC} (V)	V_{OL} (V) MAX.	V_{CC} (V)
GP2A200LCS0F	(Following diagram [A])	Multi types of paper detectable, light modulation type, with connector, sensitivity adjusted	5 to 15	4.75	5.25	30*1	5	0.4	5
GP2A240LCS0F		Applicable to inverter fluorescent lamp, light modulation type, with connector, sensitivity adjusted	5 to 15	4.75	5.25	30*1	5	0.4	5
GP2A250LCS0F		Static electricity resistant, applicable to inverter fluorescent lamp, light modulation type, with connector, sensitivity adjusted	2.5 to 12.5	4.75	5.25	30*1	5	0.4	5
GP2A25J0000F		Multi types of paper detectable, light modulation type, with connector, sensitivity adjusted	3 to 7	4.75	5.25	30*1	5	0.4	5
GP2A230LRS0F	(Following diagram [B])	Compact, hook type (GP2A231LRSAF), multi types of paper detectable, light modulation type, with connector	3 to 7	4.75	5.25	20*1	5	0.4	5
GP2A230LRSAF									
GP2A231LRSAF▲									
GP2A25NJJ00F	(Following diagram [A])	Multi types of paper detectable, light modulation type, sensitivity adjusted, improved light-resistance characteristic for inverter lighting, built-in visible light cut filter	3 to 7	4.75	5.25	30*1	5	0.4	5
GP2A25DJ000F		Multi types of paper detectable, light modulation type, with connector, sensitivity adjusted	3 to 7	4.75	5.25	30*1	5	0.4	5
GP2A28AJ000F		Multi types of paper detectable, light modulation type, with connector, sensitivity adjusted, hook type	3 to 7	4.75	5.25	30*1	5	0.4	5

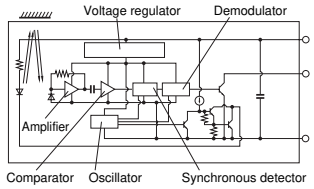
✻ Topr: –10 to +60°C (GP2A25J0000F, etc.)
–10 to +70°C (GP2A200LCS0F, GP2A240LCS0F, GP2A250LCS0F, GP2A230LRS0F, GP2A230LRSAF, GP2A231LRSAF)

*1 Smoothing value $R_L = \infty$

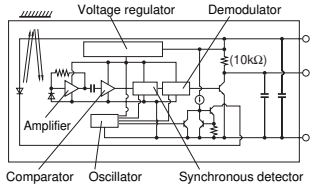
The model marked with ▲ may not be available in the near future. Contact with SHARP for details before use.

[Internal connection diagram]

[A]



[B]



GP2A25J0000F
(GP2A25NJJ00F, GP2A200LCS0F, GP2A240LCS0F)

GP2A250LCS0F

GP2A25DJ000F

GP2A230LRS0F

GP2A231LRSAF▲

GP2A28AJ000F

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RoHS

■ Photointerrupters for Specific Applications

◆Transmissive Type

<Case type, with encoder function>

(Ta = 25°C)

Model No.	Absolute maximum ratings		Electro-optical characteristics					
	Vcc (V)	Topr (°C)	Operating voltage Vcc (V) TYP.	Output signal	Resolution	Response frequency f (kHz) MAX.	Response frequency IF (mA)	Dissipation current (output side) Icc (mA) MAX.
GP1A057RBKLF	6	–10 to +70	3.3	Digital 2 output (Phase A/B)	Linear scale slit pitch 0.17 (mm) (150LPI)	60	20	7
GP1A054RDKLF	6	–10 to +70	3.3		Linear scale slit pitch 0.0847 (mm) (300LPI)	60	20	5.5
GP1A057SGKLF	6	–10 to +70	3.3		Linear scale slit pitch 0.56 (mm) (45LPI)	25	20	5.5
GP1A058SCK0F	6	–10 to +70	3.3		Linear scale slit pitch 0.14 (mm) (180LPI)	60	20	5.5
GP1A101C2KSF	6.5	–10 to +70	3.3	Digital 2 output (Multiplying output)	Resolution for reading: 180 LPI (Pitch: 0.14 mm) Output resolution: 360 LPI	120	20	20

* High precision read and low affection of angle error from vibration thanks to the multi-segment PD system.
Duty ratio: 50±15%, phase difference: 90±45°


GP1A054RDKLF

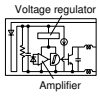

GP1A057RBKLF
(GP1A057SGKLF)


GP1A058SCK0F


GP1A101C2KSF

<For amusement use>

(Ta = 0 to +40°C)

Model No.	Internal connection diagram	Features	Detecting and emitting gap (mm)	Slit width (mm)	Electro-optical characteristics: Operating voltage Vcc (V) MIN.	Operating voltage Vcc (V) MAX.	Low level output voltage VOL (V) MAX.	Low level output voltage Light cut-off	Low level output voltage IOL (mA)	Low level output voltage VCC (V)
GP1A204HCS0		Connector with lock, screw mounting type, high resistant to noise	4.0	0.5	10.8	24	0.4	Yes	5	10.8 to 24


GP1A204HCS0

◆Reflective Type

<Case type, phototransistor output>

(Ta = 25°C)

Model No.	Internal connection diagram	Features	Electro-optical characteristics: Peak photocurrent ICP (mA)	Peak photocurrent IF (mA)	Peak photocurrent VCE (V)	Response time tr (µs) TYP.	Response time IC (mA)	Response time RL (kΩ)	Response time VCE (V)
GP2S29SVJ00F		Long focal distance (with prism system*1), compact, screw mounting type	0.4 to 3.0*1	20	5	38	0.5	1	2

※ Topr: –25 to +85°C *1 Space between prism and sensor is 8 mm.


GP2S29SVJ00F

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RoHS

<For amusement use>

(Ta = 25°C)

Model No.	Features	Electro-optical characteristics		
		Supply voltage Vcc (V)	Dissipation current Icc (mA)	Response frequency f (Hz)
GP2A222HCKA	Employs reflective type, pinball detector, connector with lock In conjunction with an IC, detects beam interruption*1	4.5 to 16.5	MAX. 12	MAX. 500

*1 Used together with interface IC for control (IR3N184)

GP2A222HCKA

■ Proximity Sensor

(Ta = 25°C)

Model No.	Features	Absolute maximum ratings		Electro-optical characteristics			
		Vcc (V)	Topr (°C)	Dissipation current Icc (μA) TYP.	Detecting distance Lon (mm) MIN.	Non-detecting distance Loff (mm) MAX.	Peak emission wavelength λp (nm)
GP2AP002S00F	Compact size (4.0 × 2.0 × 1.25 t mm) Drastically reduced LED current consumption by employing a light modulation system Built-in LEDs for simple optical design and I²C output	3.8	–25 to +85	240	25	150	940

☆New product

RoHS

■ Proximity Sensor with Integrated Ambient Light Sensor

(Ta = 25°C)

Model No.	Features	Absolute maximum ratings		Electro-optical characteristics								
					Proximity sensor portion			Ambient light sensor portion				
										Output current		
		V_{CC} (V)	Topr (°C)	Dissipation current Icc (μA) TYP.	Detecting distance Lon (mm) MIN.	Non-detecting distance Loff (mm) MAX.	Peak emission wavelength λp (nm)	Recommended illuminance range Ev (lx) MIN.	Peak sensitivity wavelength λp (nm)	I_{O1} (μA) TYP.	I_{O2} (μA) MAX.
GP2AP002A00F▲	LED and ambient light sensor combined in a single package (5.6 × 2.1 × 1.25 t mm) Drastically reduced LED current consumption by employing a light modulation system Built-in LEDs for simple optical design Proximity sensor: I²C output Ambient light sensor: logarithmic current output	3.8	–25 to +85	270	25	150	940	3 to 55 000	555	30 (at Ev = 1 000 lx)	1 (at Ev = 0 lx)

The model marked with ▲ may not be available in the near future. Contact with SHARP for details before use.

(Ta = 25°C)

Model No.	Features	Absolute maximum ratings		Electro-optical characteristics					
					Proximity sensor portion		Ambient light sensor portion		
		V_{CC} (V)	Topr (°C)	Dissipation current Icc (μA) TYP.	Detecting distance Lon (mm) TYP.	Peak emission wavelength λp (nm)	Recommended illuminance range Ev (lx)	Output resolution (bit)	ADC conversion time Tint (ms) TYP.
☆GP2AP030A00F	LED and ambient light sensor combined in a single package (4.0 × 2.1 × 1.25 t mm) Built-in LEDs for simple optical design Illuminance output: digital 16-bit output (Minimum detectable illuminance: 0.02 lx) I²C output compatible (proximity sensor, ambient light sensor)	5.5	–35 to +85	65	100	940	0.02 to 10 000	16	100

GP2AP002S00F

GP2AP002A00F▲

GP2AP030A00F

Optoelectronics

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☆New product

■ Proximity/Gesture Sensor with Integrated Ambient Light Sensor

(Ta = 25°C)

Model No.	Features	Absolute maximum ratings		Electro-optical characteristics						
						Proximity/gesture sensor portion		Ambient light sensor portion		
		V_{CC} (V)	Topr (°C)	Dissipation current Icc (μA) TYP.	Dissipation current Icc (Gesture) (μA) TYP.	Detecting distance Lon (mm) TYP.	Peak emission wavelength λp (nm)	Recommended illuminance range Ev (lx)	Output resolution (bit)	ADC conversion time Tint (ms) TYP.
☆GP2AP052A00F	LED and ambient light sensor combined in a single package (5.6 × 2.1 × 1.25 t mm) Built-in LEDs for simple optical design Illuminance output: digital 16-bit output (Minimum detectable illuminance: 0.02 lx) I^2C output compatible Gesture recognition: directional hand movements detected without touching the screen	5.5	–35 to +85	65	200	100	940	0.02 to 10 000	16	100

GP2AP052A00F

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